SiGe Semiconductor Devices for High-Performance Cryogenic Power Electronics, Phase I



Completed Technology Project (2003 - 2003)

Primary U.S. Work Locations and Key Partners



Organizations Performing Work	Role	Туре	Location
Glenn Research Center(GRC)	Lead	NASA	Cleveland,
	Organization	Center	Ohio
GPD Optoelectronics	Supporting	Industry	Salem, New
Corporation	Organization		Hampshire

Primary U.S. Work Locations	
New Hampshire	Ohio



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Organizational Responsibility

Responsible Mission Directorate:

Space Technology Mission Directorate (STMD)

Lead Center / Facility:

Glenn Research Center (GRC)

Responsible Program:

Small Business Innovation Research/Small Business Tech Transfer



Small Business Innovation Research/Small Business Tech Transfer

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Project Management

Program Director:

Jason L Kessler

Program Manager:

Carlos Torrez

Principal Investigator:

Rufus R Ward

Technology Areas

Primary:

- TX03 Aerospace Power and Energy Storage
 - ☐ TX03.3 Power

 Management and
 Distribution
 - ☐ TX03.3.4 Advanced Electronic Parts

